


8PACK**DDR4 GAMING XTREEM**

T-FORCE | DDR4 XTREEM

T-Force Gaming DDR4 XTREEM x 8PACK



**T-FORCE fit with OCUK,
Powered and Certified by 8 pack**

Now the T-FORCE series XTREEM and DARK PRO are certified by OCUK famous overlocking champion "8 pack" to publish all the powerful specifications, which means these DRAM modules are all passed the serious stress performance test and quality insured to be the special 8 packs and T-FORCE edition. No doubt and guaranteed will be the top notch!!

Below is the details and link: <https://goo.gl/Zqvfa5>



The unprecedented moment of glory

In the date of January 13th, 2017, when Thai Overclocker, "Audigy", submitted the historic DDR4 5260.8mhz to the CPUZ as DRAM world record frequency, the whole overclocking world was shocked by how amazing T-FORCE XTREEM is. Yet after the storm, the XTREEM never took the rest, Audigy sealed another world record, 5280Mhz, in the date of March 30th, 2017.



Global overclocking new record

Until this moment as May of 2017, the world's top 3 records are all in the name of TEAMGROUP T-FORCE XTREEM. Consequently, this DRAM overclocking legend is born, "The Special Edition of T-FORCE XTREEM!." It is made by high selected and hand screened IC from SAMSUNG Original 21st Nano –Micron DDR4 B-die IC topped Jedec newest RC 2.0 pcb, and high quality aluminum CNC craft heat spreader with overclocking mentor, Onepagebook, use high power laser technology autograph on the pure black coating T-FORCE name plate. The quantity of this XTREEM Special Edition is highly restricted for only 50 sets. It is only for the people who would like to ride to the journey of their own world record.

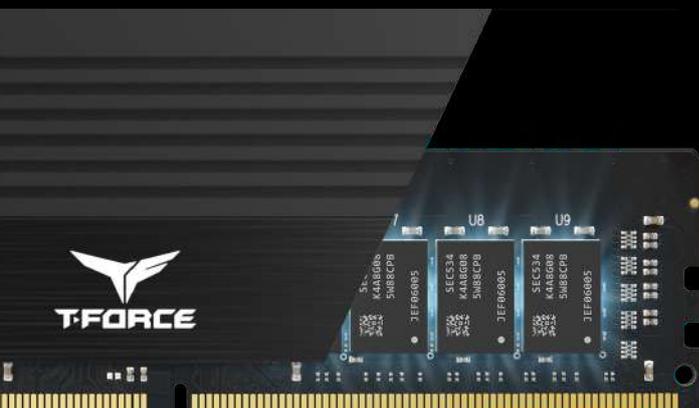
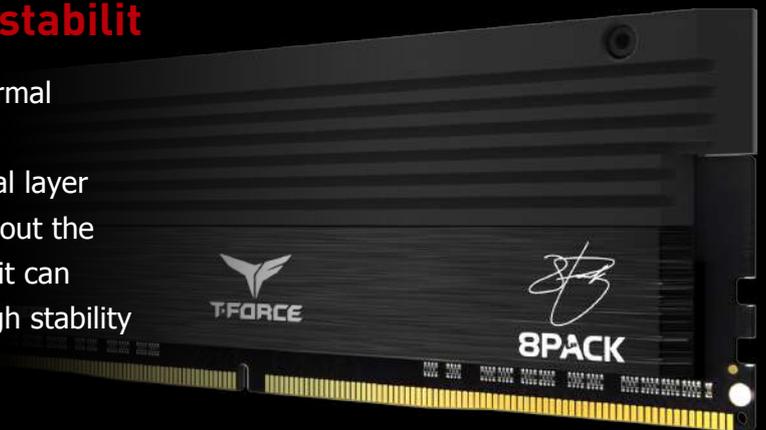


With unique trench design and improve radiating performance **10%**

The TEAMGROUP design team had built a heat spreader with an all new exterior design concept. The overclocking memory module with highest specification is built by top notch aluminum extrusion process and CNC machining. The unique trench design can increase the radiating area to improve radiating efficiency. XTREEM combines simple and magnificent design with its top specification overclocking memory module. The clean, sleek lines are able to magnify its high speed specification.

RC2.0 board largely improves stabilit

The number of PCB layers is 25% more than normal memories. This provides better efficiency and performance since the power layer and the signal layer has a farther distance between each other. Without the interference between the power and the signal, it can offer players the overclocking pleasure and a high stability overclocking memory module.



Selected high quality
SAMSUNG
original IC chips

TEAMGROUP insists on using high quality SAMSUNG original IC chips and passed through various rigorous internal tests. Its high reliability makes players feel at ease.

Ultra low working voltage Save energy up to **40%**

With low working voltage 1.2~1.4V from DDR4 XTREEM, it is not only energy saving but it can also reduce the temperature and the heat generated to offer the high speed running memory a stable and long time operation.



XMP2.0 **1** step overclocking technology

All XTREEM series support Intel XMP 2.0. It is only one step away to experience the high speed sensation of overclocking.

QVL approved by motherboard manufacturers

Multiple compatibility verifications with mainstream DDR4 motherboards to make sure its stability with all motherboards on the QVL(Qualified Vendor List). Therefore, you wouldn't have to worry about compatibility issues when purchasing high speed memory.



Main Feature

- The finest crafted heat spreader with unique trench design
- High-efficiency aluminum heat spreader
- 10 layers of circuit board
- Selected high quality SAMSUNG original IC chips
- 1.2V~1.4V ultra low working voltage
- Support Intel XMP 2.0 smart overclocking technology
- QVL approved by motherboard manufactures in the market



Specification

Item	Specification				
Module Type	288 Pin Unbuffered DIMM Non ECC				
Capacity	8GBx4 / 16GBx4	8GBx2 / 8GBx4		8GBx2	
Frequency	3200	3600	4000	4133	4500
Data transfer bandwidth	25,600 MB/s (PC4 25600)	28,800 MB/s (PC4 28800)	32,000 MB/s (PC4 32000)	33,000 MB/s (PC4 33000)	36,000MB/s (PC4 36000)
CL-Value	CL16-18-18-38	CL16-18-18-38	CL18-19-19-39	CL18-20-20-44	18-20-20-44
Voltage	1.35V		1.4V		1.45V
Heat Sink	Aluminum heat-sink				
Operation System	Desktop or notebook computer with DDR4 Memory Slots Required OS: Windows 10 / 8.1 / 8 / 7 / Vista / XP				
Dimensions	48(H) x 134(L) x 9(W)mm				
Warranty	Lifetime Warranty				

Ordering Information

Description	Color	Timings/Voltage	Capacity	Team P/N
TEAM XTREEM UD-D4 3200	Black	CL16-18-18-38 1.35V	8GBx4	TXBD432G3200HC14BQC01
			16GBx4	TXBD464G3200HC16CQC01
TEAM XTREEM UD-D4 3600		CL16-18-18-38 1.35V	8GBx4	TXBD432G3600HC16AQC01
			16GBx4	TXBD464G3600HC17AQC01
TEAM XTREEM UD-D4 4000		CL18-19-19-39 1.35V	8GBx2	TXBD416G4000HC18GDC01
			8GBx4	TXBD432G4000HC18FQC01
TEAM XTREEM UD-D4 4133		CL18-20-20-44 1.4V	8GBx2	TXBD416G4133HC18EDC01
TEAM XTREEM UD-D4 4500		CL18-20-20-44 1.45V	8GBx2	TXBD416G4500HC18EDC01

Above technical information is based on industry standard data and tested to be reliable. However, Team makes no warranty, either expressed or implied, as to its accuracy and assumes no liability in connection with the use of this product.

Team reserves the right to make changes in specifications at any time without prior notice.